

Pages 1 to 14

TRANSISTORS, LOW POWER, NPN

BASED ON TYPE 2N2219A

ESCC Detail Specification No. 5201/003

Issue 2	April 2007





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DCR No.	CHANGE DESCRIPTION
187, 265	Specification up issued to incorporate editorial and technical changes per DCRs.







ISSUE 2

TABLE OF CONTENTS

<u>1.</u>	<u>GENERAL</u>	<u>5</u>
1.1	Scope	5
1.2	Applicable Documents	5
1.3	Terms, Definitions, Abbreviations, Symbols and Units	5
1.4	The ESCC Component Number and Component Type Variants	5
1.4.1	The ESCC Component Number	5
1.4.2	Component Type Variants	5
1.5	Maximum Ratings	5
1.6	Physical Dimensions and Terminal Identification	6
1.7	Functional Diagram	7
1.8	Materials and Finishes	8
<u>2.</u>	REQUIREMENTS	<u>8</u>
2.1	General	8
2.1.1	Deviations from the Generic Specification	8
2.1.1.1	Deviation from Screening Tests - Chart F3	8
2.2	Marking	8
2.3	Terminal Strength	8
2.4	Electrical Measurements at Room, High and Low Temperatures	8
2.4.1	Room Temperature Electrical Measurements	9
2.4.2	High and Low Temperatures Electrical Measurements	13
2.5	Parameter Drift Values	13
2.6	Intermediate and End-Point Electrical Measurements	13
2.7	Power Burn-in Conditions	14
2.8	Operating Life Conditions	14
APPENDI	X 'A'	15



1. GENERAL

1.1 <u>SCOPE</u>

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 5000
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 <u>The ESCC Component Number</u>

The ESCC Component Number shall be constituted as follows:

Example: 520100301

Detail Specification Reference: 5201003

• Component Type Variant Number: 01 (as required)

1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant No.	Based on Type	Case	Lead Material and Finish	Weight max g
01	2N2219A	TO-39	D2	1.2
02	2N2219A	TO-39	D3 or D4	1.2

The lead material and finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

1.5 <u>MAXIMUM RATINGS</u>

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.



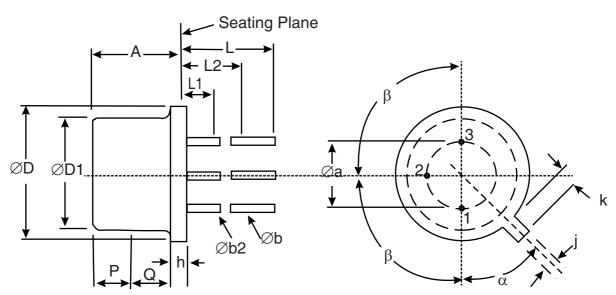
Characteristics	Symbols	Maximum Ratings	Unit	Remarks
Collector-Base Voltage	V _{CBO}	75	V	Over entire
Collector-Emitter Voltage	V _{CEO}	40	V	operating temperature
Emitter-Base Voltage	V _{EBO}	6	V	range
Collector Current	I _C	800	mA	Continuous
Power Dissipation	P _{tot1}	0.8	W	At T _{amb} ≤ +25°C Note 1
	P _{tot2}	3	W	At T _{case} ≤ +25°C Note 1
Operating Temperature Range	Тор	-65 to +200	°C	Note 2
Storage Temperature Range	T _{stg}	-65 to + 200	°C	Note 2
Soldering Temperature	T _{sol}	+260	°C	Note 3

NOTES:

- For T_{amb} or T_{case} > +25°C, derate linearly to 0W at +200°C.
 For Variants with tin-lead plating or hot solder dip lead finish all testing performed at T_{amb} > +125°C shall be carried out in a 100% inert atmosphere.
- Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.

1.6 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

Metal Can Package (TO - 39) - 3 Lead



Symbols	Dimensio	Notes	
Зуппоотз	Min	Max	Notes
Øa	4.83	5.35	

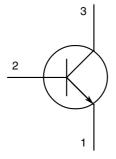


Cumbale	Dimensio	ons mm	Notes
Symbols	Min	Max	Notes
A	6	6.6	
Øb	0.4	0.533	2, 3
Øb2	0.4	0.483	2, 3
ØD	8.31	9.4	
ØD1	7.75	8.51	5
h	0.229	3.18	
j	0.71	0.864	
k	0.737	1.14	4
L	12.7	19	2
L1	-	1.27	2, 3
L2	6.35	-	2, 3
Р	2.54	-	5
Q	-	-	6
α	45° [1, 7	
β	90° I	90° BSC	

NOTES:

- 1. Terminal identification is specified by reference to the tab position where Lead 1 = emitter, Lead 2 = base and Lead 3 = collector.
- 2. Applies to all leads.
- 3. Øb2 applies between L1 and L2. Øb applies between L2 and 12.7mm from the seating plane. Diameter is uncontrolled within L1 and beyond 12.7mm from the seating plane.
- 4. Measured from the maximum diameter of the actual device.
- 5. This zone is controlled for automatic handling. The variation in actual diameter within this zone shall not exceed 0.254mm.
- 6. The details of outline in this zone are optional.
- 7. Measured from the Tab Centreline.

1.7 <u>FUNCTIONAL DIAGRAM</u>



- 1. Emitter.
- 2. Base.
- 3. Collector.

NOTES:

1. The collector is internally connected to the case.



1.8 MATERIALS AND FINISHES

Materials and finishes shall be as follows:

- a) Case
 - The case shall be hermetically sealed and have a metal body with hard glass seals.
- b) Leads

As specified in Component Type Variants.

2. REQUIREMENTS

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 Deviations from the Generic Specification

2.1.1.1 Deviation from Screening Tests - Chart F3

High Temperature Reverse Bias Burn-in and the subsequent Final Measurements for HTRB shall be omitted.

2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) The ESCC qualified components symbol (for ESCC qualified components only).
- (b) The ESCC Component Number.
- (c) Traceability information.

2.3 TERMINAL STRENGTH

The test conditions for terminal strength, tested as specified in the ESCC Generic Specification, shall be as follows:

Test Condition: E, lead fatigue.

2.4 ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES

Electrical measurements shall be performed at room, high and low temperatures.

2.4.1 Room Temperature Electrical Measurements

The measurements shall be performed at T_{amb} =+22 ±3oC.



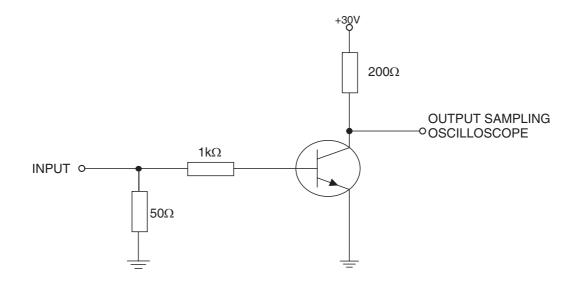


Characteristics	Symbols	MIL-STD-750	Test Conditions	Lin	nits	Units
		Test Method		Min	Max	
Collector-Base Breakdown Voltage	V _{(BR)CBO}	3001	$I_C = 10\mu A$, Bias Condition D	75	-	V
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	3011	I _C = 10mA, Bias Condition D Note 1	40	-	V
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	3026	$I_E = 10\mu A$, Bias Condition D	6	-	V
Collector-Base Cut- off Current	I _{CBO}	3036	V _{CB} = 60V, Bias Condition D	-	10	nA
Emitter-Base Cut- off Current	I _{EBO}	3061	V _{EB} = 3V, Bias Condition D	-	10	nA
Collector-Emitter Saturation Voltage	V _{CE(sat)1}	3071	3071 I _C =150mA I _B =15mA Note 1		300	mV
	V _{CE(sat)2}	3071	I _C =500mA I _B =50mA Note 1	-	1	V
Base-Emitter Saturation Voltage	V _{BE(sat)}	3066	Test Condition A I _C =150mA I _B =15mA Note 1	-	1.2	V
Forward-Current Transfer Ratio	h _{FE1}	3076	V _{CE} =10V ; I _C =10mA Note 1	75	-	-
	h _{FE2}	3076	V _{CE} =10V ; I _C =150mA Note 1	100	300	-
	h _{FE3}	3076	V _{CE} =10V ; I _C =500mA Note 1	40	-	-
Magnitude of Small-Signal Short- Circuit Forward- Current Transfer Ratio	h _{fe}	3306	V _{CE} =20V, I _C =20mA f=100MHz Note 2	2.5	-	_
Output Capacitance	C _{obo}	3236	V_{CB} =10V I_E =0A 100kHz≤ f £1MHz Note 2	-	8	pF
Turn-on Time	t _{on}	-	I _C =150mA I _B =15mA Notes 2, 3	-	35	ns
Turn-off Time	t _{off}	-	I _C =150mA I _B =15mA Notes 2, 4	-	300	ns

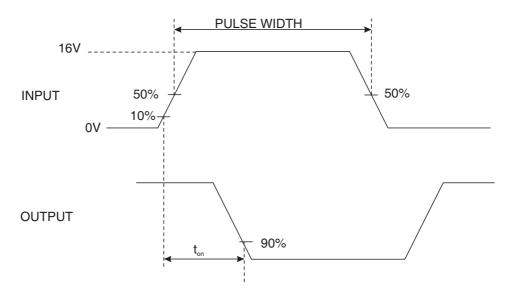


NOTES:

- 1. Pulse measurement: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$
- 2. For AC characteristics read and record measurements shall be performed on a sample of 32 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 3. t_{on} shall be measured using the following test circuit. The input waveform shall be supplied by a pulse generator with the following characteristics: $Z_{OUT} = 50\Omega$, $t_r \le 2$ ns, Pulse Width = 200 ± 10 ns, Duty Cycle $\le 2\%$. The output waveform shall be monitored on an oscilloscope with the following characteristics: $Z_{IN} \ge 100$ k Ω , Input Capacitance ≤ 12 pF, $t_r \le 5$ ns.

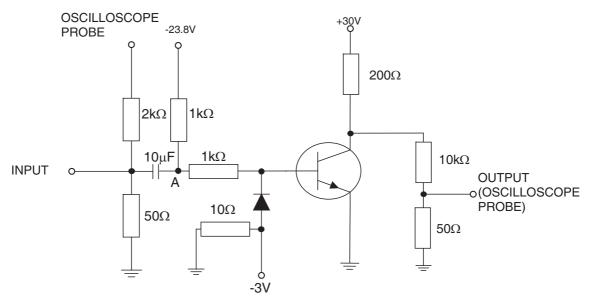


VOLTAGE WAVEFORMS

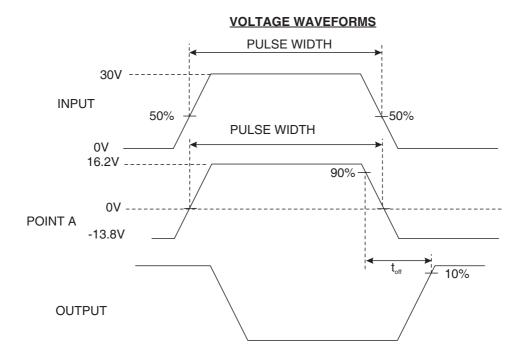


4. t_{off} shall be measured using the following test circuit. The input waveform shall be supplied by a pulse generator with the following characteristics: $Z_{OUT} = 50\Omega$, $t_r \le 2$ ns, Pulse Width = 10μ s, Duty Cycle $\le 2\%$. The output waveform shall be monitored on an oscilloscope with the following characteristics: $Z_{IN} \ge 100 k\Omega$, Input Capacitance $\le 12 p$ F, $t_r \le 5$ ns.





Diode is 1N916 or equivalent





2.4.2 <u>High and Low Temperatures Electrical Measurements</u>

Characteristics	, , , , , , , , , , , , , , , , , , , ,	Limits		Units		
		Test Method	Note 1	Min	Max	
Collector-Base Cut- off Current	I _{CBO}	3036	T _{amb} =+150(+0-5)°C V _{CB} =60V, Bias Condition D	-	10	μА
Forward-Current Transfer Ratio 1	h _{FE1}	3076	T _{amb} =-55(+5-0)°C V _{CE} =10V I _C =10mA Note 2	35	-	-

NOTES:

- 1. Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 2. Pulse measurement: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%

2.5 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22 ±3oC.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	ristics Symbols Limits		Limits		Units
	Drift		Abso	olute	
		Value Δ	Min	Max	
Collector-Base Cut-off Current	I _{CBO}	±2 or (1) ±100%	-	10	nA
Collector-Emitter Saturation Voltage 1	V _{CE(sat)1}	±30 or (1) ±15%	-	300	mV
Forward-Current Transfer Ratio 2	h _{FE2}	±15%	100	300	-

NOTES:

1. Whichever is the greater referred to the initial value.

2.6 <u>INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS</u>

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22 ±3oC.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The limit values for each characteristic shall not be exceeded.



Characteristics	Symbols	Limits		Units
		Min	Max	
Collector-Base Cut-off Current	I _{CBO}	-	10	nA
Collector-Emitter Saturation Voltage 1	V _{CE(sat)1}	-	300	mV
Forward-Current Transfer Ratio 2	h _{FE2}	100	300	-

2.7 <u>POWER BURN-IN CONDITIONS</u>

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+20 to +50	°C
Power Dissipation	P _{tot}	As per Maximum Ratings P _{tot} derated at the chosen T _{amb}	W
Collector-Base Voltage	V _{CB}	10 to 40	V

2.8 <u>OPERATING LIFE CONDITIONS</u>

The conditions shall be as specified for Power Burn-in.





APPENDIX 'A'

AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Room Temperature Electrical Measurement Note 2) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification. A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from High and Low Temperatures Electrical Measurements	All characteristics specified may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes characteristic measurements at high and low temperatures per the Detail Specification. A summary of the pilot lot testing shall be provided if required by the Purchase Order.